



HIGH-SIDE AND LOW-SIDE GATE DRIVER IN SO-8

Description

The DGD2005 is a mid-voltage/high-speed gate driver capable of driving N-channel MOSFETs in a half-bridge configuration. High-voltage processing techniques enable the DGD2005's high-side to switch to 200V in a bootstrap operation. The 30ns (maximum) propagation delay matching between the high-side and low-side drivers allows high-frequency switching.

The DGD2005 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. The low-side gate driver and logic share a common ground.

The DGD2005 is available in a space saving SO-8 package and operates over an extended -40°C to +125°C temperature range.

Applications

- Battery Power Tools and Appliances
- Light Electric Vehicles (LEV)
- Inverters

Vcc Vcc Vs HiN DGD2005 Vs COM LO

Typical Configuration

Features

- Floating High-Side Driver in Bootstrap Operation to 200V
- Drives Two N-Channel MOSFETs in Half Bridge Configuation
- 290mA Source/600mA Sink Output Current Capability
- Outputs Tolerant to Negative Transients
- Wide Logic and Low-Side Gate Driver Supply Voltage: 10V to 20V
- Logic Input (HIN and LIN) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Delay Matching of 30ns Maximum
- Undervoltage Lockout for High-Side and Low-Side Drivers
- Extended Temperature Range: -40°C To +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SO-8 (Standard)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.075 grams (Approximate)



SO-8 Top View

Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel	
DGD2005S8-13	DGD2005	13	12	2500	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

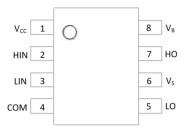
Marking Information



);; = Manufacturer's Marking DGD2005 = Product Type Marking Code YY = Year (ex: 21 = 2021) WW = Week (01 to 53)



Pin Diagrams

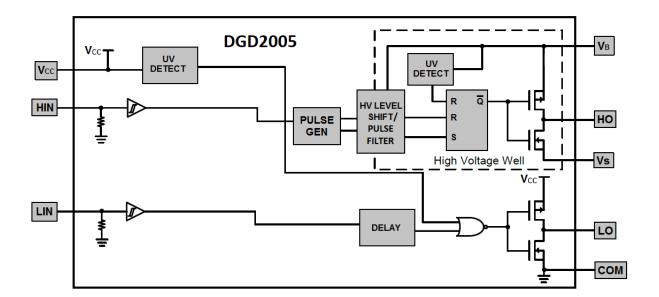


Top View: SO-8

Pin Descriptions

Pin Number	Number Pin Name Function		
1	Vcc	Low-Side and Logic Fixed Supply	
2	HIN	Logic Input for High-Side Gate Driver Output, in Phase with HO	
3	LIN	Logic Input for Low-Side Gate Driver Output, in Phase with LO	
4	COM	Low-Side Return	
5	LO	Low-Side Gate Drive Output	
6	Vs	High-Side Floating Supply Return	
7	НО	High-Side Gate Drive Output	
8	VB	High-Side Floating Supply	

Functional Block Diagram





Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	V _B	-0.3 to +224	V
High-Side Floating Supply Offset Voltage	Vs	V _B -24 to V _B +0.3	V
High-Side Floating Output Voltage	Vно	Vs-0.3 to V _B +0.3	V
Offset Supply Voltage Transient	dVs / dt	50	V/ns
Low-Side and Logic Fixed Supply Voltage	Vcc	-0.3 to +24	V
Low-Side Output Voltage	VLO	-0.3 to Vcc+0.3	V
Logic Input Voltage (HIN and LIN)	V _{IN}	-0.3 to V _{CC} +0.3	V

Thermal Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P _D	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja 200		°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	T∟	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	Vв	Vs + 10	Vs + 20	V
High Side Floating Supply Offset Voltage	Vs	(Note 6)	200	V
High Side Floating Output Voltage	V_{HO}	Vs	V _B	V
Low Side and Logic Fixed Supply Voltage	Vcc	10	20	V
Low Side Output Voltage	VLO	0	Vcc	V
Logic Input Voltage	Vin	0	5	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for V_S of -5V to +200V.



DC Electrical Characteristics (VBIAS (VCC, VBS) = 15V, @TA = +25°C, unless otherwise specified.) (Note 7)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	V _{IH}	2.5	_	_	V	_
Logic "0" Input Voltage	VIL	_	-	0.6	V	_
High Level Output Voltage, VBIAS - VO	VoH	_	0.05	0.2	>	$I_O = 2mA$
Low Level Output Voltage, Vo	Vol	_	0.02	0.1	٧	$I_0 = 2mA$
Offset Supply Leakage Current	ILK	_		50	μΑ	$V_B = V_S = 200V$
Quiescent V _{BS} Supply Current	I_{BSQ}	20	75	130	μΑ	V _{IN} = 0V or 5V
Quiescent Vcc Supply Current	Iccq	60	120	180	μΑ	VIN = 0V or 5V
Logic "1" Input Bias Current	I _{IN+}	_	5.0	20	μΑ	VIN = 5V
Logic "0" Input Bias Current	I _{IN} -	_	1	2.0	μΑ	VIN = 0V
V _{BS} Supply Undervoltage Positive Going Threshold	V _{BSUV+}	8.0	8.9	9.8	V	_
V _{BS} Supply Undervoltage Negative Going Threshold	V_{BSUV}	7.4	8.2	9.0	>	_
Vcc Supply Undervoltage Positive Going Threshold	Vccuv+	8.0	8.9	9.8	٧	_
V _{CC} Supply Undervoltage Negative Going Threshold	V _{CCUV} -	7.4	8.2	9.0	>	_
Undervoltage Lockout Hysterisis	V _{UVLOH}	0.3	0.7	_	٧	_
Output High Short Circuit Pulsed Current	lo+	130	290	_	mA	$V_O = 0V$, $V_{IN} = Logic$ "1", $PW \le 10\mu s$
Output Low Short Circuit Pulsed Current	lo-	270	600	_	mA	V _O = 15V, V _{IN} = Logic "0", PW ≤ 10µs

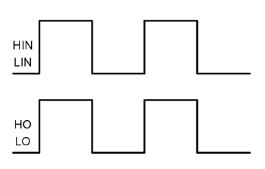
Note: 7. The V_{IN} and I_{IN} parameters are referenced to COM and are applicable to the two logic pins: HIN and LIN. The V_O and I_O parameters are referenced to COM and are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	ton		100	300	ns	Vs = 0V
Turn-Off Propagation Delay	toff		100	280	ns	Vs = 0V or 200V
Delay Matching	t _{DM}		_	30	ns	_
Turn-On Rise Time	t _R	_	90	220	ns	$V_S = 0V$
Turn-Off Fall Time	tF	_	30	80	ns	Vs = 0V



Timing Waveforms



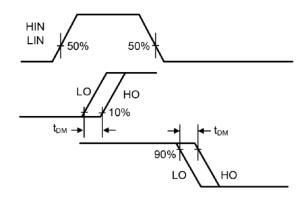


Figure 1. Input / Output Timing Diagram

Figure 2. Delay Matching Waveform Definitions

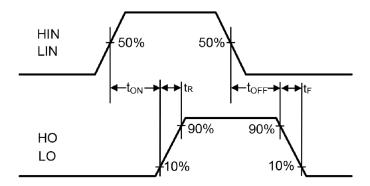


Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (Vcc = 15V, @TA = +25°C, unless otherwise specified.)

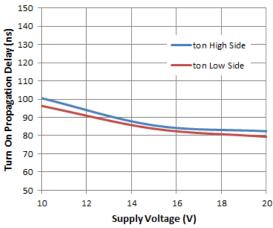


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

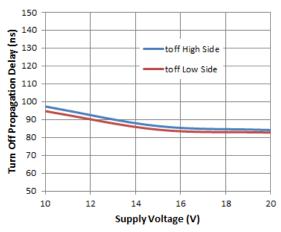


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

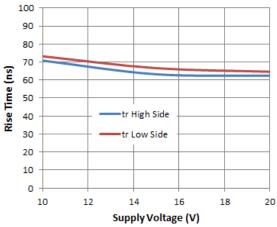


Figure 8. Rise Time vs. Supply Voltage

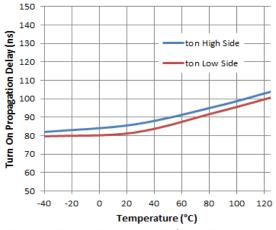


Figure 5. Turn-on Propagation Delay vs. Temperature

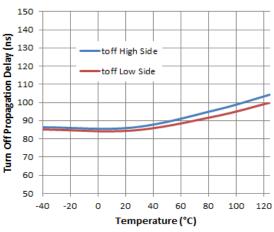


Figure 7. Turn-off Propagation Delay vs. Temperature

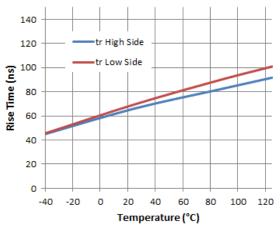


Figure 9. Rise Time vs. Temperature



Typical Performance Characteristics (continued)

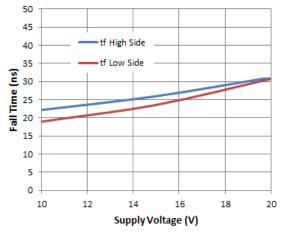


Figure 10. Fall Time vs. Supply Voltage

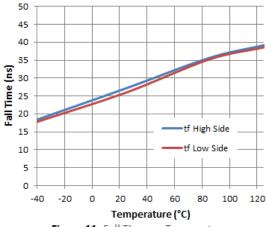


Figure 11. Fall Time vs. Temperature

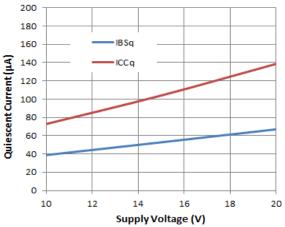


Figure 12. Quiescent Current vs. Supply Voltage

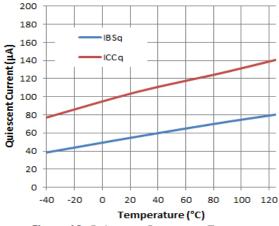


Figure 13. Quiescent Current vs. Temperature

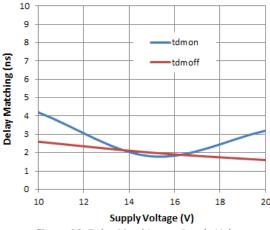


Figure 14. Delay Matching vs. Supply Voltage

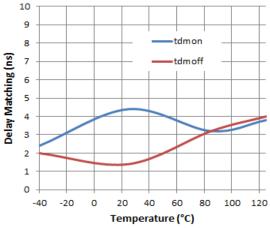


Figure 15. Delay Matching vs. Temperature



Typical Performance Characteristics (continued)

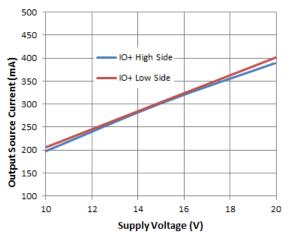


Figure 16. Output Source Current vs. Supply Voltage

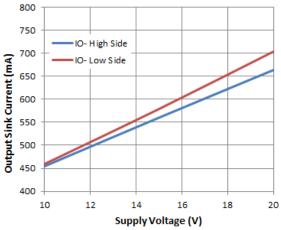


Figure 18. Output Sink Current vs. Supply Voltage

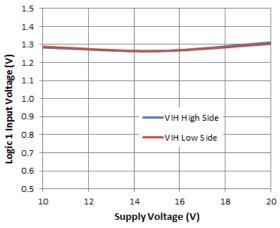


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

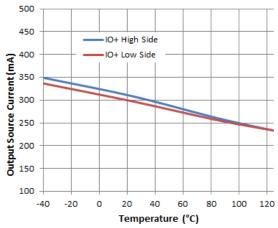


Figure 17. Output Source Current vs. Temperature

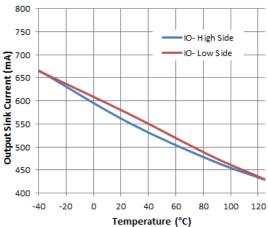


Figure 19. Output Sink Current vs. Temperature

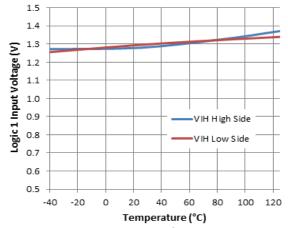


Figure 21. Logic 1 Input Voltage vs. Temperature



Typical Performance Characteristics (continued)

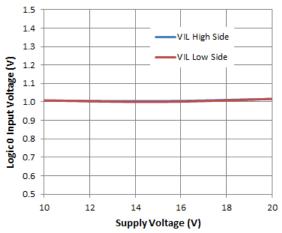


Figure 22. Logic O Input Voltage vs. Supply Voltage

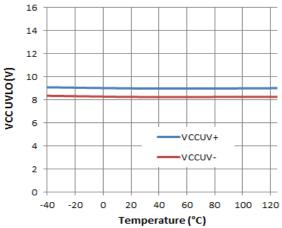


Figure 24. VCC UVLO vs. Temperature

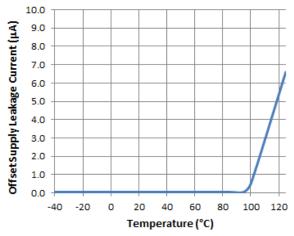


Figure 26. Offset Supply Leakage Current vs. Temperature

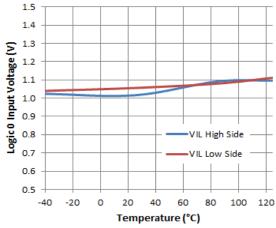


Figure 23. Logic 0 Input Voltage vs. Temperature

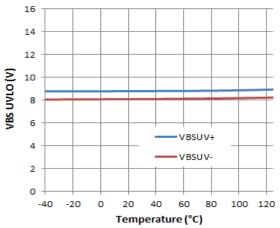


Figure 25. VBS UVLO vs. Temperature

Тур

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6.00

1.27

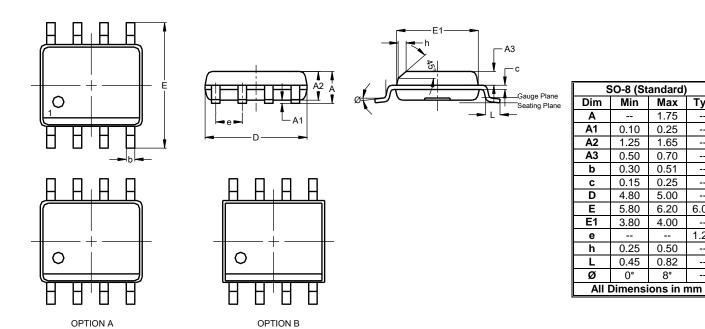
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Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Standard)

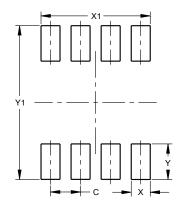


Suggested Pad Layout

(TOP VIEW)

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8 (Standard)



(TOP VIEW)

Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Y	1.505
Y1	6.50

For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device terminals and PCB tracking. Note:



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